

AMPMODU | AMPMODU HV-100/HV-190

TE Internal #: 215297-8

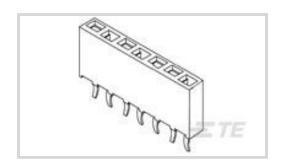
PCB Mount Receptacle, Vertical, Board-to-Board, 8 Position, 2.54 mm [.1 in] Centerline, Gold, Through Hole - Solder, Black,

AMPMODU HV-100/HV-190

View on TE.com >



Connectors > PCB Connectors > PCB Headers & Receptacles



PCB Connector Assembly Type: PCB Mount Receptacle

PCB Mount Orientation: Vertical
Connector System: Board-to-Board

Number of Positions: 8

Number of Rows: 1

Features

Product Type Features

PCB Connector Assembly Type	PCB Mount Receptacle
Connector System	Board-to-Board
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board

Configuration Features

Stackable	Yes
PCB Mount Orientation	Vertical
Number of Positions	8
Number of Rows	1

Body Features

Connector Profile	Standard
Primary Product Color	Black

Contact Features

Contact Protection Type	Closed Entry Housing
Mating Square Post Dimension	.63 mm[.024 in]
PCB Contact Termination Area Plating Material Thickness	3 – 5 μm[118.11 – 196.85 μin]
Contact Layout	Inline
Mating Pin Diameter	.63 mm[.024 in]



Contact Shape & Form	Square
PCB Contact Termination Area Plating Material	Tin
Contact Base Material	Phosphor Bronze
Contact Mating Area Plating Material	Gold
	30 μin
Contact Type	Socket
Contact Current Rating (Max)	3 A
Termination Features	
Rectangular Termination Post & Tail Thickness	.2 mm[.008 in]
Rectangular Termination Post & Tail Width	.69 mm[.027 in]
Termination Post & Tail Length	3.1 mm[.122 in]
Termination Method to Printed Circuit Board	Through Hole - Solder
Mechanical Attachment	
PCB Mount Retention Type	Retention Solder Tails
PCB Mount Retention	With
Housing Features	
Mating Entry Location	Тор
Centerline (Pitch)	2.54 mm[.1 in]
Housing Material	Polyester - GF
Dimensions	
Connector Height	7 mm[.276 in]
PCB Thickness (Recommended)	1.6 mm
Usage Conditions	
Operating Temperature Range	-65 – 125 °C, -55 – 105 °C
Operation/Application	
Solder Process Feature	Board Standoff
Industry Standards	
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Quantity	88
Packaging Type	Tray



Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235) Does not contain REACH SVHC
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.
Solder Process Capability	Wave solder capable to 265°C

Product Compliance Disclaimer

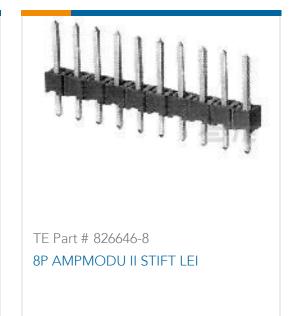
This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts

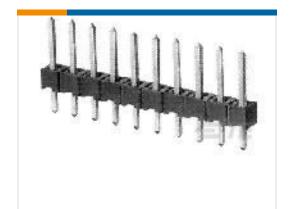












TE Part # 826648-8 08P AMPMODU II PIN HDR.



TE Part # 215267-8 AMPMODU,BREAK-AWAY



TE Part # 826647-8 8P AMPMODU II STIFT LEI



TE Part # 826653-8 8P MOD2 STIFT LEI



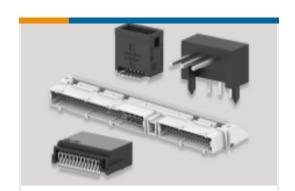
TE Part # 966306-8
MOD2 ST-LEI SMD 8P



TE Part # 966710-8

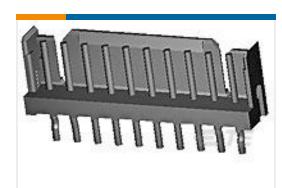
MODU II PIN HEADER, SGL ROW,
SMD- 8 POS

Also in the Series | AMPMODU HV-100/HV-190

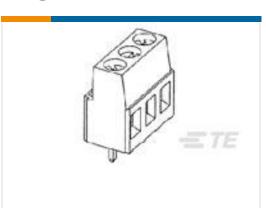


PCB Headers & Receptacles(345)

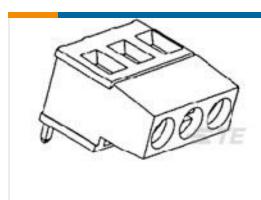
Customers Also Bought



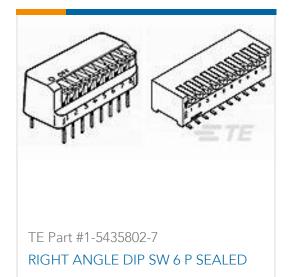
TE Part #1-292161-3 CT P/HDR ASSY V 13P W/KINK NAT

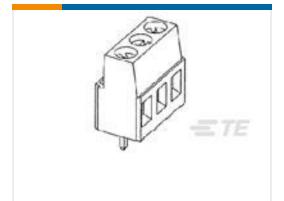


TE Part #282858-4 4P. TERMI-BLOK PCB MOUNT 90



TE Part #1-1546073-8 18POS 5.08MM TERMI-BLOK





TE Part #282841-7
TERMI-BLOK PCB MOUNT 7P. 5



TE Part #282858-6 6P. TERMI-BLOK PCB MOUNT 90



TE Part #DTF13-12PD HDR, 12P, BRN, RA, SN/NI/CU, D





Documents

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_215297-8_E.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_215297-8_E.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_215297-8_E.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Datasheets & Catalog Pages

1773393_ AMPMODU_EUROPEAN_STANDARD_PRODUCTS

English